

Docket No.: INTEL-0021

PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In Application of

Confirmation No.: 7414

Edward A. BURTON, Kumar ANSHUMALI

Group Art Unit: 2818

Serial No: 10/607,550

Examiner: Nguyen, Dao H.

Filed: June 27, 2003

Customer No.: 34610

For: ADDITION OF METAL LAYERS WITH SIGNAL REALLOCATION TO A MICROPROCESSOR FOR INCREASED FREQUENCY AND LOWER POWER

U.S. Patent and Trademark Office  
Customer Window, Mail Stop Amendment  
Randolph Building  
401 Dulany Street  
Alexandria, Virginia 22314

Dear Sir:

Transmitted herewith is an Amendment and/or Reply in the above identified application.

- ☐ No additional fee is required.  
☐ Also attached:

The fee has been calculated as shown below:

	NO. OF CLAIMS	HIGHEST PREVIOUSLY PAID FOR	EXTRA CLAIMS	RATE	FEE
Total Claims	17	33	0	x \$50.00 =	
Independent Claims	1	3	0	x \$200.00=	
If multiple claims newly presented, add \$360.00					
Fee for extension of time					
<b>TOTAL FEE DUE</b>					<b>\$ -0-</b>

- ☐ Please charge my Deposit Account No. 16-0607 in the amount of \$\_\_\_\_. An additional copy of this transmittal sheet is submitted herewith.
- ☐ A check in the amount of \$ \_\_\_\_\_ (Check # \_\_\_\_\_) is attached.
- ☒ The Commissioner is hereby authorized to charge payment of any fees associated with this communication or credit any overpayment, to Deposit Account No. 16-0607, including any filing fees under 37 C.F.R. 1.16 for presentation of extra claims and any patent application processing fees under 37 C.F.R. 1.17.

Respectfully submitted,  
FLESHNER & KIRKPATRICK LLP

Mark L. Fleshner, Esq.  
Registration No. 34,596

Samuel W. Nitros, Esq.  
Registration No. 39,318

P.O. Box 221200  
Chantilly, VA 20153-1200  
(703) 766-3701 MLF/SWN/lm  
Date: JUNE 30, 2006

**Please direct all correspondence to Customer Number 34610**

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Intel Docket No: P15914 (2112-021)

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re patent application of : Assignee: Intel Corporation

BURTON, E. et al. : Confirmation No. 7414

Serial No. 10/607,550 : Examiner: Nguyen, Dao H

Filed: June 27, 2003 : Group Art Unit: 2818

For: ADDITION OF METAL LAYERS WITH SIGNAL REALLOCATION TO A  
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### AMENDMENT

U.S. Patent and Trademark Office  
Customer Service Window, Mail Stop Amendment  
Randolph Building  
401 Dulany Street  
Alexandria, Virginia 22314

June 30, 2006

Sir:

The following amendments and remarks are submitted in response to the Office  
Action mailed on June 12, 2006, in connection with the above-identified application.

**Amendments to the Claims** are in the Listing of Claims beginning on page 2.

**Remarks** begin on page 6.